

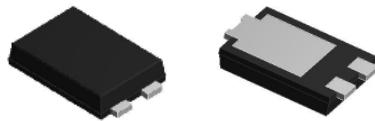
TO-277 Plastic-Encapsulate Diodes

Schottky Rectifier Diode

Features:

- $I_{F(AV)}$ 10A
- V_{RRM} 200V
- High surge current capability
- Low peak forward voltage

TO-277



Cathode & Heatsink Anode 1
 Anode 2

Applications:

- Rectifier

Marking

- SB10200

Limiting Values(Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	KSB10200
Repetitive Peak Reverse Voltage	V_{RRM}	V		200
Maximum RMS Voltage	V_{RMS}	V		140
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave · Resistance load · TL(Fig.1)	10
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave · 1 cycle · $T_a=25^\circ C$	200
Junction Temperature	T_J	°C		-55 ~ +150
Storage Temperature	T_{STG}	°C		-55 ~ +150

Electrical Characteristics ($T=25^\circ C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		KSB10200
Peak Forward Voltage	V_F	V	$I_F=10.0A$	$T_a=25^\circ C$	0.80(TYP) 0.90(MAX)
				$T_a=125^\circ C$	0.66(TYP) 0.74(MAX)
Peak Reverse Current	I_{RRM1}	mA	$V_{RM}=V_{RRM}$	$T_a=25^\circ C$	0.02(TYP) 0.08(MAX)
	I_{RRM2}			$T_a=125^\circ C$	10(TYP) 20(MAX)
Thermal Resistance(Typical)	$R_{\theta J-A}$	°C/W	Between junction and ambient		80
	$R_{\theta J-L}$		Between junction and terminal		5
Typical junction capacitance	C_J	nF	$VR=4.0 V, f=1 MHz$		0.95

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3" x 0.3" (8.0 mm x 8.0 mm) copper pad areas

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

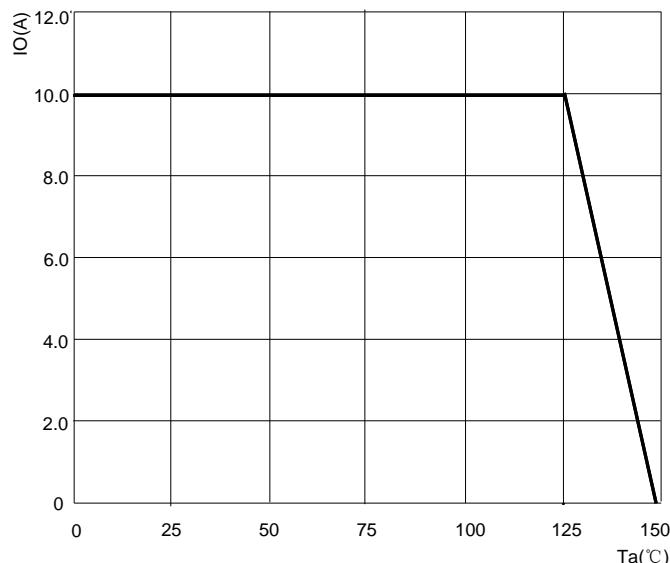


FIG.2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

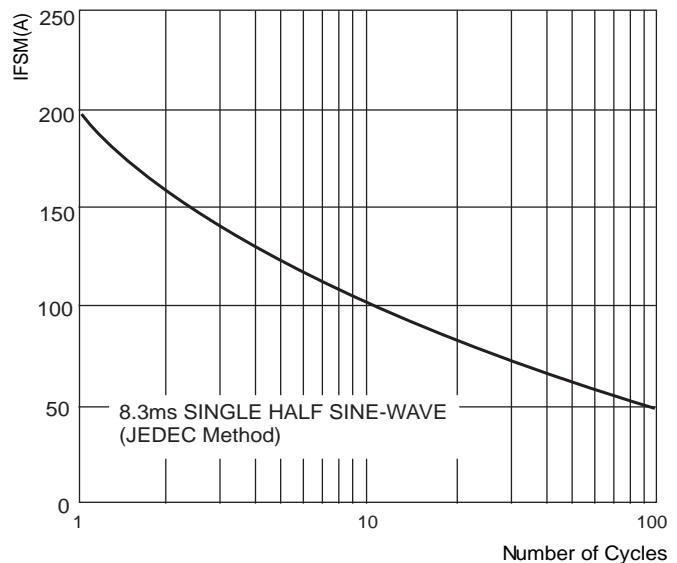


FIG.3: INSTANTANEOUS FORWARD CHARACTERISTICS

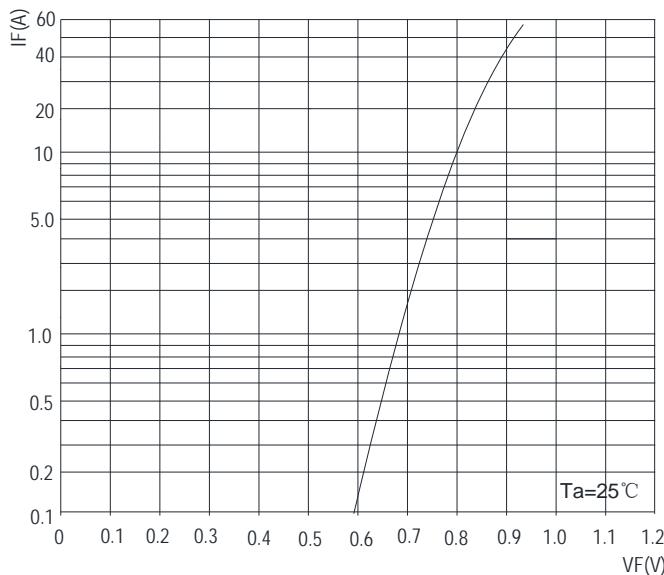
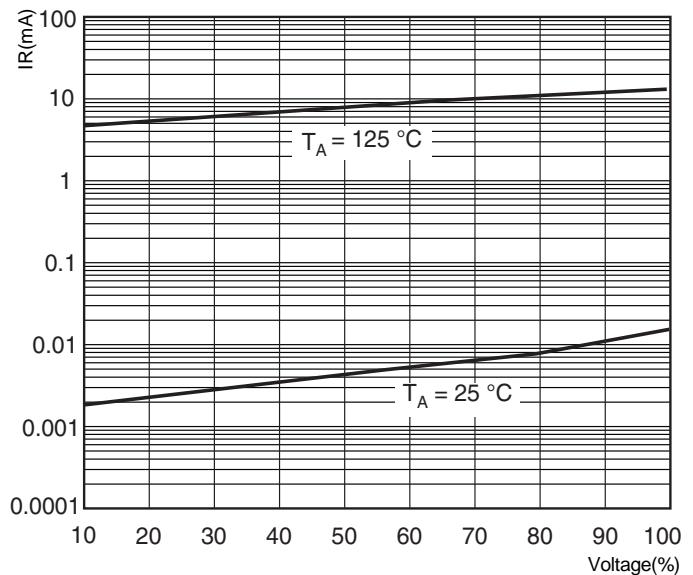
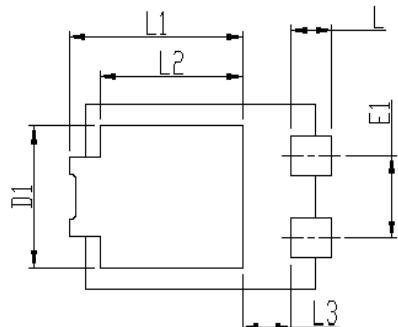
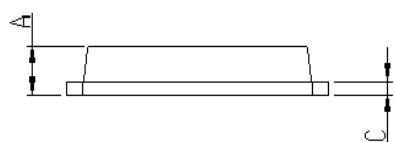
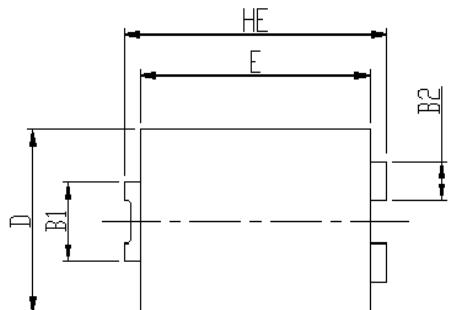


FIG.4: TYPICAL REVERSE CHARACTERISTICS

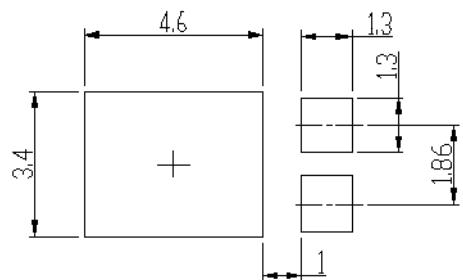


TO- 277 Package Outline Dimensions



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
HE	6.4	6.6	0.252	0.260
E	5.6	5.8	0.220	0.228
D	4.	4.	0. 61	0. 69
B1	1.7	1.9	0.067	0.075
B2	0.8	1	0.031	0.039
A	1.05	1.2	0.041	0.047
C	0.3	0.4	0.012	0.016
L	0.85	1.1	0.033	0.043
L1	4.2	4.4	0.165	0.173
L2	3.52 Typ.		0.139 Typ.	
L3	1.1	1.4	0.043	0.055
D1	3	3.3	0.118	0.130
E1	1.86 Typ.		0.073 Typ.	

TO- 277 Suggested Pad Layout



Note:

1. Controlling dimension:in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

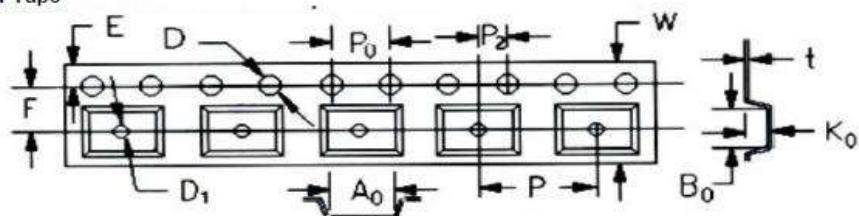
TO-277 (卷盤)

單位: mm

項目	卷盤	中盒	外箱
尺寸 (mm)	$\Phi 330$	$338 \times 338 \times 39$	$370 \times 370 \times 360$
數量 (只)	5K	$5K \times 2$ (卷) = 10K	$5K \times 2$ (卷) $\times 7$ (盒) = 70K

載帶:

Embossed Carrier Tape



尺寸規格	P2	F	E	A0	B0	K0	P1	P0	W	D0
公差mm	2.0 ± 0.07	7.5 ± 0.1	1.75 ± 0.1	4.38 ± 0.1	6.9 ± 0.1	4.0 ± 0.1	8.0 ± 0.07	4.0 ± 0.07	16 ± 0.2	1.55 ± 0.05

卷盤(mm):

